

# PRODUCT SPECIFICATION

(產品規格書)

產品名稱 Description	產品料號 Part No.	圖號 Drawing No.
PCI 120P Connector Right Angle	8206-120C10RU	8206D02012

PRODUCT NAME	<b>DOCUMENT No.:</b>	<b>Rev.</b>	OUPIIN
(產品名稱)	(文件編號)	(版本)	
PCI 120P Connector	8206spec-120R	В	(歐品)
Right Angle	<b>Approved</b>	Checked	Prepared
	(核準)	(審核)	(製作)
rught ringle	Q.A. Section Chief	Joseph Yen	05.03/2018



# 1. SCOPE (範圍)

This product specification defines the product performance and the test methods to ascertain the performance of the PCI 120PIN Connector Right Angle, which is designed and manufactured by Oupiin Electronic Co.,Ltd.

(本產品規格書規定了由歐品電子有限公司生產的 PCI 120PIN Connector Right Angle,,型連接器,產品的特性及測試方法.)

# 2. REFERENCE DOCUMENTS (參考文件)

MIL-STD-1344A Test method for electrical connector

(電子連接器測試方法)

MIL-STD-202F Test method for electrical components

(電子零件測試方法)

EIA 364 Test method for electrical components

(電子零件測試方法)

# 3. FEATURE & DIMENSIONS (特徵及尺寸)

# 3.1. PRODUCT DIMENSION (產品尺寸)

These connectors shall have the dimensions as shown in drawing.

(本產品的相關尺寸參考圖面.)

# 3.2. PCB/PANEL LAYOUT (印刷電路板佈局)

The recommended PCB layout is shown in drawing.

(本產品適用的 PCB layout 參考圖面.)

# 3.3. BILL OF MATERIAL (材料清單)

Harmful material control follow the requirement of RoHS. The bill of material and product number is described in drawing.

(有害物質控制符合RoHS指令要求.本產品使用的材料參考附件.)

# 3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC (機械及電氣特性)

The connector shall have the mechanical and electrical performance as described in drawing.

(本產品的機械及電氣特性見圖面:)

# 3.5. PACKAGING (包裝)

Products shall be packaged according to requirements specified in purchase order for safe delivery. Products required carrier tape should meet the proper specification per purchase order. Connector



container and the packaging specification is shown in package drawing.

(產品包裝可依客戶指定要求.本產品採用 Tube Packag 包裝,具體見包裝圖面.)

# 3.6 RATING CURRENT AND RATING VOLTAGE 額定電流與額定電壓

Rating current is 1.0 A, rating voltage is 250V DC/AC RMS.

額定電流 1.0 A,額定電壓 250V DC/AC RMS。

# 3.7 OPERATING TEMPERATURE 使用溫度

Temperature range: -55°C~+85°C,.

溫度範圍:-55°C~+85°C。

# 4. ENVIRONMENTAL(環境要求)

# 4.1. SOLDERABILITY (可焊件)

Connectors meet solder ability to MIL-STD-202F. Finish shall be free of contaminants. (產品可焊性符合 MIL-STD-202F 標準規定的相關要求,表面不得有污染物.)

# 4.2. RESISTANCE TO SOLDER HEAT (耐焊接熱)

#### WAVE SOLDERING (波峰接)

Each cycle consists of three consecutive phases.

(每個焊接週期包括三個連續的階段)

#### 1. Preheat (預熱)

The steady temperature of the preheat zone is 90~125°C.

(預熱區最終溫度控制在90~125°C)

#### 2. Soldering (焊接)

To avoid the secondary tin-melting, the temperature on PCB upper surface is 160°C Max. for products with lead, or 200°C Max. for lead-free products. The temperature of the PCB bottom surface shall not be exceed 100°C more than the temperature of the PCB upper surface. The peak temperature is during 220~245°C for products with lead, or 230~255°C for lead-free products. The tin dip time is duration for 3~10 seconds.

(有鉛產品板面溫度不得超過160°C,無鉛產品板面溫度不得超過200°C,以防止貼片零件二次熔錫。板面溫度與板底的溫度溫差不得超過100°C。板下溫度峰值有鉛產品維持在220~245°C,無鉛產品控制在230~255°C。浸錫時間控制在3~10秒。)

#### 3. Cool Down (冷卻)

Cool down shall not exceed 6°C per second.

(冷卻速度不超過6℃/秒.)

Note: (說明)

Device temperature measurements are referenced from the top-center of the package outer surface.

(設備溫度量測時以從頂部中間位置測量為準.)

# 5. PERFORMANCE AND TEST DESCRIPTION

# (性能及測試)

# 5.1. REQUIREMENT (要求)

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in **Table I**.

(本產品設計符合附表一所列的機械,電氣及環境要求.)

# 5.2. TEST CONDITION (測試條件)

Unless otherwise specified, all tests shall be performed at ambient environmental conditions. (除非特別注明,所有測試在室溫條件下完成;)

# 5.3. SAMPLE SELECTION (樣品選擇)

Test samples shall be selected at random from current production. No test samples shall be reused. Samples are pre-conditioned with 10cycles of durability. Each group shall be containing 5 test samples. (測試樣品從現生產的產品中隨機抽取,所有測試過的樣品不得重複使用. 樣品已預先插拔10次,每組測試有5個樣品;)



# **Table I: Test Requirements and Procedures**

(附錄一:測試要求)

Items (項目)	Requirements (要求)	Test Methods (檢測方法)
1. Confirmation of Product (產品確認)	Product shall be conforming to the requirements of applicable product drawing. 產品必須符合相關產品圖面的要求。	Visually, dimensions and functionally inspected per applicable product drawing. 依相關產品圖面,檢查產品的外觀、尺寸及功能。
2. Contact Resistance (接觸阻抗)	30 mΩ Max. initial (最大.初態)	Subject mated contacts assembled in housing to closed circuit of 100 mA max. at open circuit voltage of 10 mV max.  (所述固定在外殼裏的端子連結到一個封閉回路中測試:電流 100 mA,電壓 10 mV max.)
3. Insulation Resistance (絕緣阻抗)	1000 MΩ Min. (最小)	Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector.  MIL-STD-202, Method 302, Condition B (500 V DC±10%).  (測試產品端子間以及端子與接地間的電阻,適用:MIL-STD-202,方法 302,條件 B )(500V DC±10%)
4. Dielectric Strength (耐電壓)	Connector must withstand test potential of 500 V AC for 1 minute. Current leakage must be 0.5 mA max. (樣品必須承受測試電壓 500V AC,時間一分鐘,漏電流不大於 0.5 mA.)	Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector. MIL-STD-202, Method 301.  (測試產品端子間以及端子與接地間的電壓,適用:MIL-STD-202,方法 301。)
5. Durability (耐久性)	Contact Resistance: $30 \text{ m}\Omega$ Max. after testing. (測試後接觸阻抗最大 $30\text{m}\Omega$ )	The sample should be mounted the tester and fully mated and unmated 100 cycles specified at the rate of 25mm/min (重復進行配合產品 100 次插拔.)
6. Solder ability (可焊性)	Appearance of the specimen shall be inspected after the test with the assistance of a magnifier capable of giving a magnification of 10 X for any damage such as pinholes, void or rough surface.  (樣品在測試完成後,在放大倍數為 10 倍的顯微鏡下,檢查外觀損壞如:小孔,空焊,外觀粗糙度;)	Soldering time: 3 to 5 Seconds (焊接時間: 3~5 秒) Soldering Temperature: 245±5°C. (焊接溫度: 245±5°C.)



Material Housing: I720-PA66-1

# SGS Test Report Click here

如需 SGS 測試報告請點選此處



Date:2010/04/12

1. Chemical Product And Company Identification

Product Name: NYLOY® MG-0034N-V W3

Chemical family: Polyamide resin

Chemical Name: Adipic acid-hexamethylenediamine resin

Synonyms: Polyamide resin, nylon 66 resin

Product Use: Plastics

Manufacturer/Supplier: Nytex Composites Co., Ltd.

Address: No.6, Ln.468, Sec.4, Changsui Rd., Peitou Hsiang, Changhwa County,

Taiwan, R.O.C.

Emergency Phone / Fax: (886)-4-8926225 / (886)-4-8922160

#### 2. Composition/Information On Ingredients

Components Name	Weight Percentage (%)	CAS Number
Polyamide 66 Resin	30-65	32131-17-2
Fibrous Glass	20-40	65997-17-3
Brominated Polystyrene	3-25	88497-56-7
Antimony Trioxide	2-15	1309-64-4
Modifiers	2-30	Mixture; Not Applicable
Additives	<5	Mixture; Not Applicable
Colorants	0-3	Mixture; Not Applicable

To whom may concern:

This is to acknowledge you that Nytex's material, code number

MG-0034N-V W3, is composed of Polyamide-66, with 33% glass fiber and colorants, a flame retardant grade product.



Nytex Composites Co., Ltd.



Material Housing: UL

QMFZ2 Component - Plastics

Friday, October 24, 2003

E135714

NYTEX COMPOSITES CO LTD

6 LANE 468 CHANGSUI RD, SEC 4 PEITOU HSIANG CHANGHUA HSIEN 523 TW

Material Designation: MG-0034N-V0

Product Description: Polyamide 66 (PA66), furnished as pellets.

CTI: - IEC CTI: - HVTR: - D495: - IEC Ball Pressure (°C): -

Dielectric Strength (kV/mm): - Volume Resistivity (10\*ohm-cm): - Dimensional Stability(%): - ISO Tensile Strength (MPa): - ISO Flexural Strength (MPa): - ISO Heat Deflection (°C): - ISO Tensile Impact (kJ/m²): - ISO Izod Impact (kJ/m²): - ISO Charpy Impact (kJ/m²): -

Report Date: 3/23/1991 Underwriters Laboratories Inc®

UL94 small-scale test data does not pertain to building materials, furnishings and related contents. UL 94 small-scale test data is intended solely for determining the flammability of plastic materials used in components and parts of end-product devices and appliances, where the acceptability of the combination is determined by ULI.



Material Contact: Copper Alloy (Phosphor Bronze)

# SGS Test Report Click here

如需 SGS 測試報告請點選此處



GUO CHING PRECISION CO., LTD

試 驗 成 績 表

REPORT OF MATERIAL TEST

客户: 歐品電子有限公司

1020301020

國慶精密股份有限公司

品名:

桃園縣龜山鄉大崗村大湖路2-17號

0.300x 28.0x C TEL: 03-2115391~8

С5191-Н Product 料號: Lot No

Size 日期: Date

102/03/26

FAX: 03-2115399

化 學 成 份

CHEMAICAL COMPOSITION

	· 素 EMENT	Cu	P	Sn	
規範	MAX	F	0.350	7.000	
SPEC	MIN	93.400 •	0.030	5.500	
	析值 IS VALUE	94.203	0.125	5.626	2

TEST RESULT

	項目 ITEM	抗張 Tensile Strength kgf/mm2	伸長 Elongation %	硬度 Hardness Test o	結晶粒度 Grain Size pm	導電率 Electric Conductivity
規範	CONDITION			HV	-	
SPEC	MAX	70.000	-	200.000		-
	MIN	58.000	8.000	180.000	_	
MEA	測驗值 SURE-MENT VALUE	59.710	22.040	194.000	0.010	14.500





Checked by:

